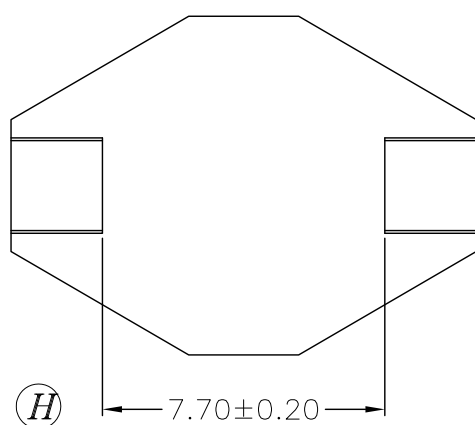
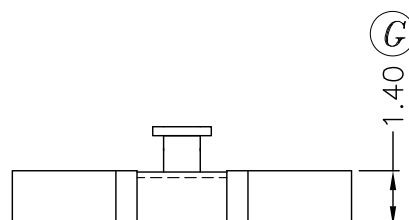
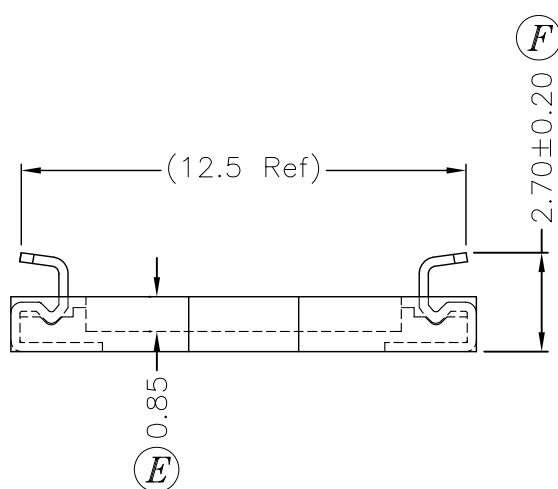
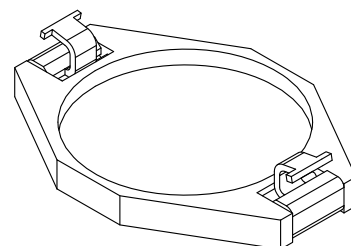
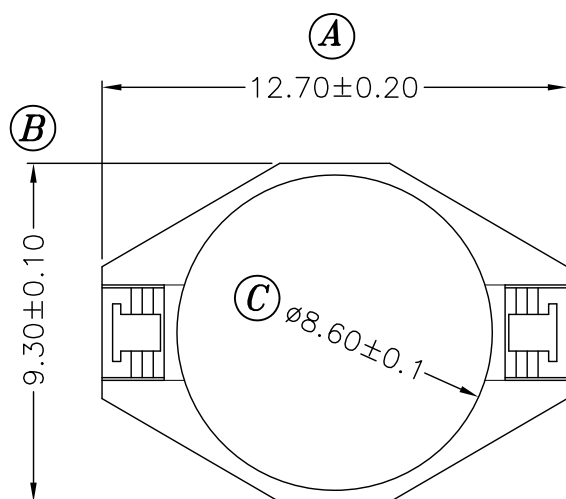


技术要求:

- 端子部分电镀亮锡 镍底1~3um 锡 3~7um
- 所有标注尺寸均为装配端子后的尺寸

REV.	REVISIONS	REC.	DATE	REV.	REVISIONS	REC.	DATE
0	初版发行		MAR 10'05				

DRAWN & DRAFTED BY	Kuang Honghua	TOLERANCES		ANGLE: ±1°	TITLE: SMD BASE DR8.5		
		0<L≤4 ±0.1	COPLANARITY 0.1mm MAX				
CHECKED & APPROVED BY	BEN LEE	4<L≤16 ±0.2		UNIT: MM	PLASTIC MATERIAL: LCP	UL REC. UL 94V-0	
		16<L≤63 ±0.3					
 广州市申拓电子有限公司 SMD-TOP ELECTRONIC (GZ) CO.,LTD. TEL:020-84842698 FAX:020-84842398				ORIGIN: GZ	METAL MATERIAL: PHOSPHOR BRONZE		PIN TENSION LOAD: /